General Features

● V_{DS} =-60V, I_D =-1.6A

$R_{DS(ON)}$ <200mΩ @ V_{GS}=-10V

$R_{DS(ON)}$ <240mΩ @ V_{GS}=-4.5V

Application

● Load/Power Switching

● Interfacing Switching

● Logic Level Shift

Package and Pin Configuration

SOT-23

Circuit diagram
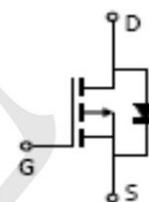
Marking: N9xxx

Absolute Maximum Ratings (T_C=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	-60	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous	I_D	-1.6	A
Pulsed Drain Current [Note 1]	I_{DM}	-8	A
Maximum Power Dissipation	P_D	1.5	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 150	℃

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient [Note 2]	$R_{θJA}$	83.3	℃/W

Electrical Characteristics (T_A = 25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V I_D=-250μA	-60	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-60V,V_{GS}=0V	-	-	-1	μA

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Gate-Body Leakage Current	I_{GSS}	V_{GS}=±20V,V_{DS}=0V	-	-	±100	nA
On Characteristics [Note 3]						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=-250μA	-1.4	-2.0	-2.6	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=-10V, I_D=-1.5A	-	150	200	mΩ
		V_{GS}=-4.5V, I_D=-1.5A	-	190	240	mΩ
Forward Transconductance	g_{FS}	V_{DS}=-5V,I_D=-1.5A	-	3	-	S
Dynamic Characteristics [Note4]						
Input Capacitance	C_{Iss}	V_{DS}=-30V,V_{GS}=0V, F=1.0MHz	-	444.2	-	PF
Output Capacitance	C_{oss}		-	19.6	-	PF
Reverse Transfer Capacitance	C_{rss}		-	17.9	-	PF
Switching Characteristics [Note 4]						
Turn-on Delay Time	$t_{d(on)}$	V_{DD}=-30V, I_D=-1.5A, V_{GS}=-10V,R_G=3Ω	-	40	-	nS
Turn-on Rise Time	t_r		-	35	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	15	-	nS
Turn-Off Fall Time	t_f		-	10	-	nS
Total Gate Charge	Q_g	V_{DS}=-30,I_D=-1.5A, V_{GS}=-10V	-	11.3	-	nC
Gate-Source Charge	Q_{gs}		-	2.7	-	nC
Gate-Drain Charge	Q_{gd}		-	1.6	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage [Note 3]	V_{SD}	V_{GS}=0V,I_S=-1.5A	-		-1.2	V
Diode Forward Current [Note 2]	I_S		-	-	-1.6	A
Reverse Recovery Time	t_{rr}	T_J = 25°C, I_F =- 1.5A di/dt = -100A/μs [Note3]	-	25		nS
Reverse Recovery Charge	Q_{rr}		-	31		nC

2

Typical Electrical and Thermal Characteristics (Curves)
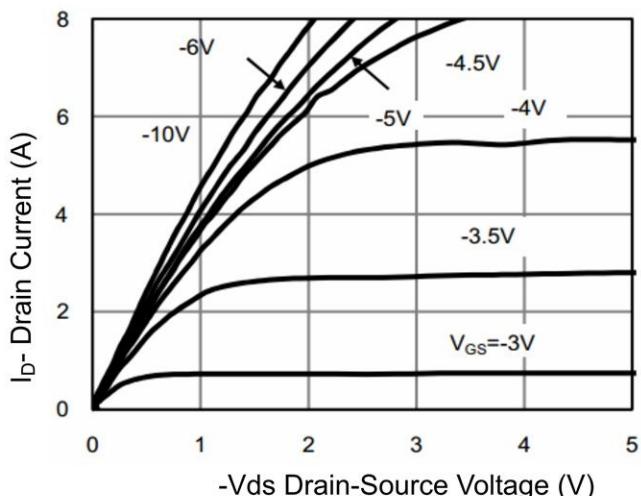
Figure 1 Output Characteristics
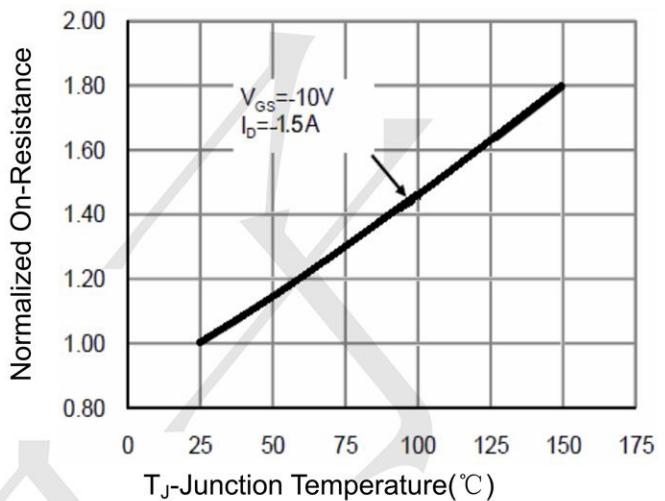
Figure 4 Rdson-Junction Temperature
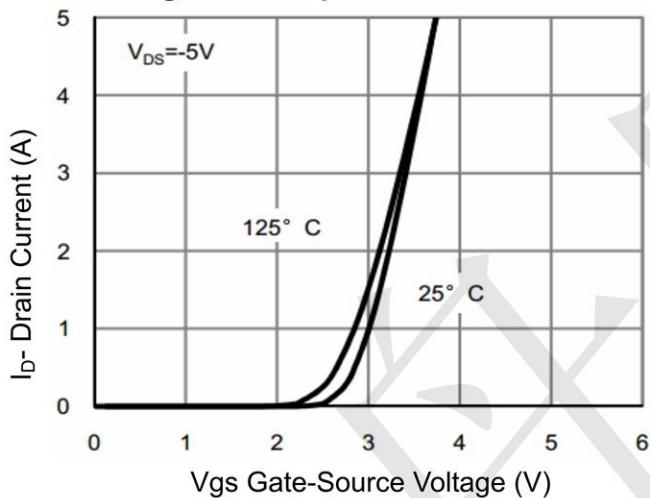
Figure 2 Transfer Characteristics

Figure 5 Gate Charge

Figure 3 Rdson- Drain Current
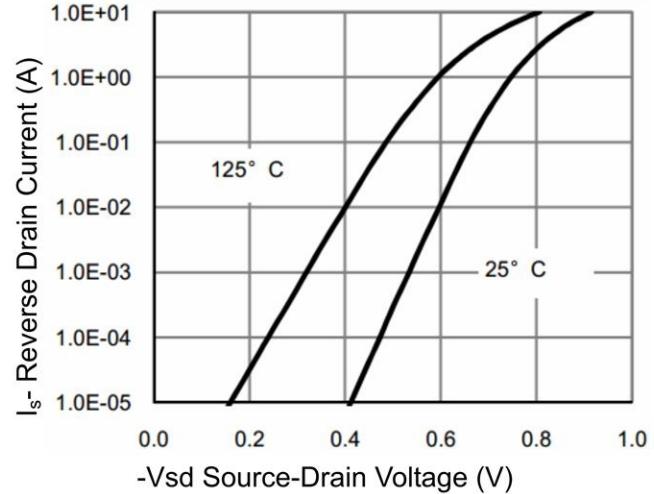
**Figure 6 Source- Drain Diode Forward**
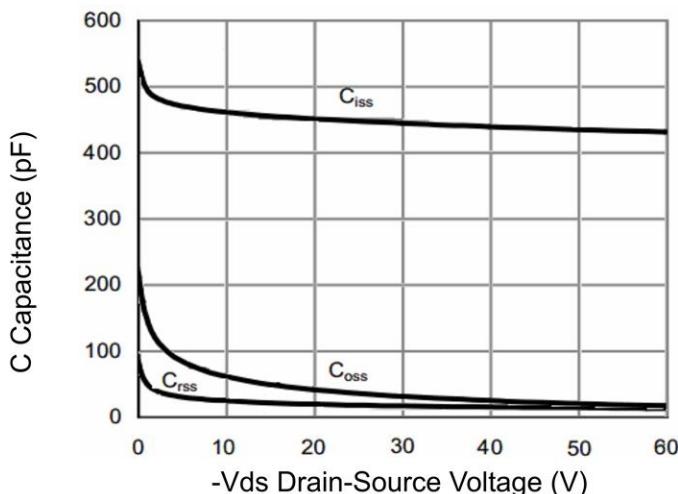
Figure 7 Capacitance vs Vds
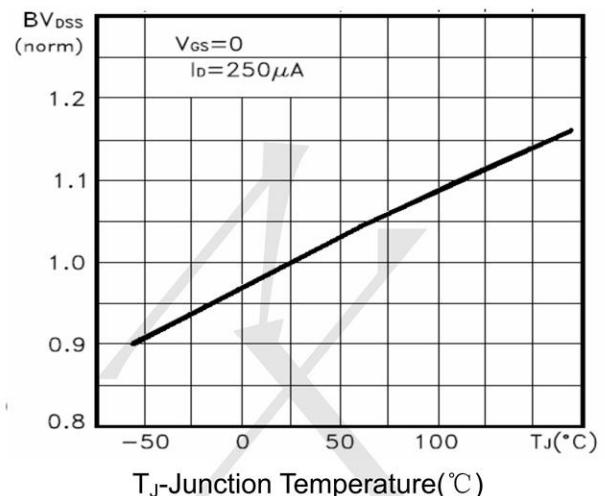

Figure 9 BV$_{DSS}$ vs Junction Temperature
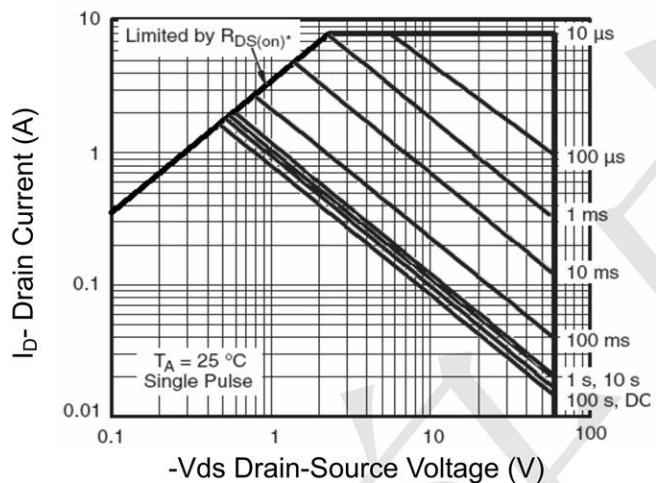
Figure 8 Safe Operation Area
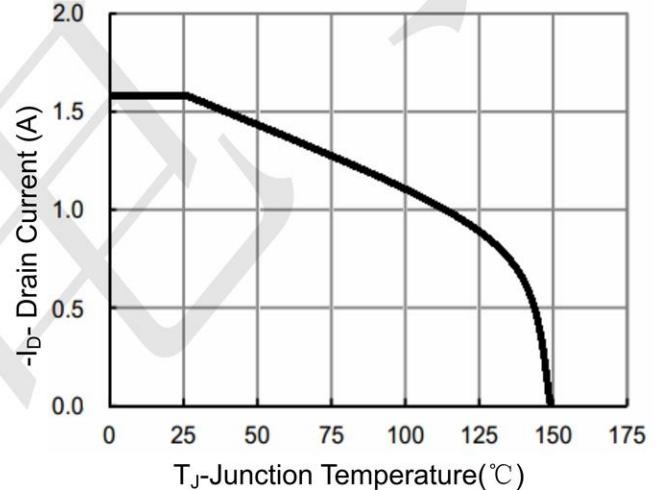

Figure 10 ID Current De-rating

Square Wave Pluse Duration(sec)
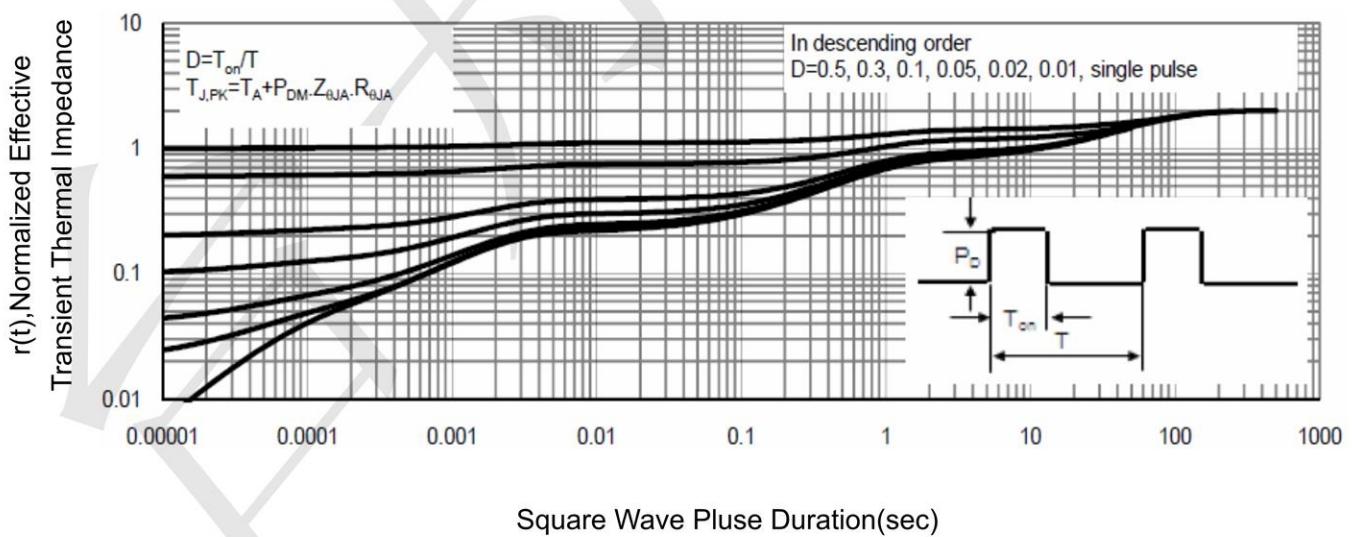
**Figure 11 Normalized Maximum Transient Thermal Impedance**

SOT-23 Package Information
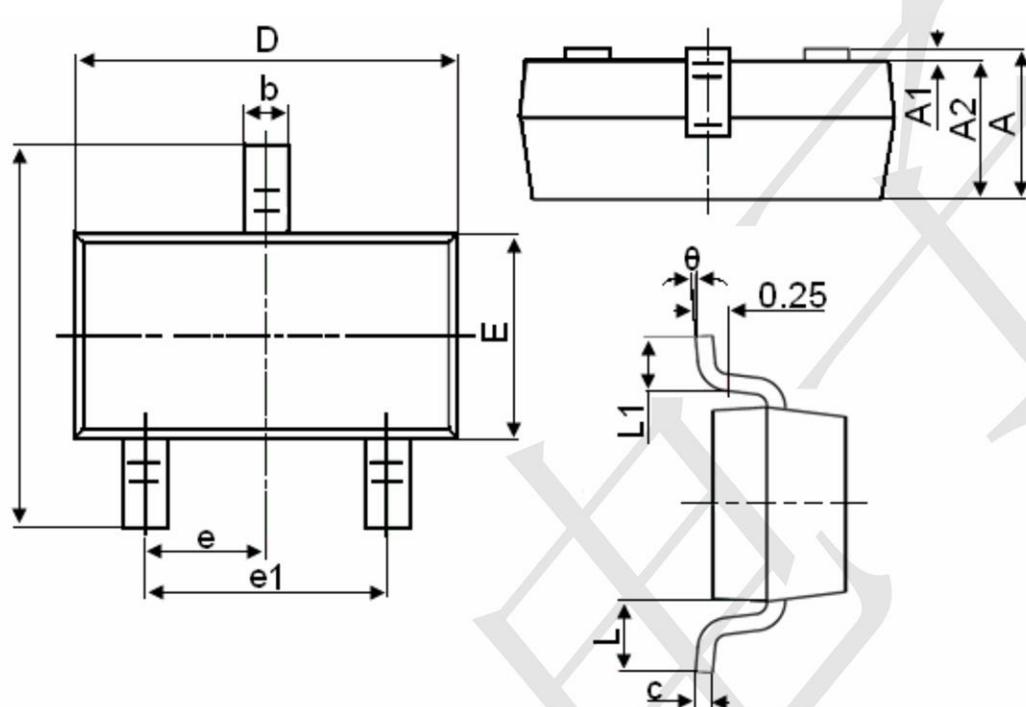
Symbol	Dimensions in Millimeters	
	MIN.	MAX.
A	0.900	1.150
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.150
D	2.800	3.000
E	1.200	1.400
E1	2.250	2.550
e	0.950TYP	
e1	1.800	2.000
L	0.550REF	
L1	0.300	0.500
θ	0°	8°